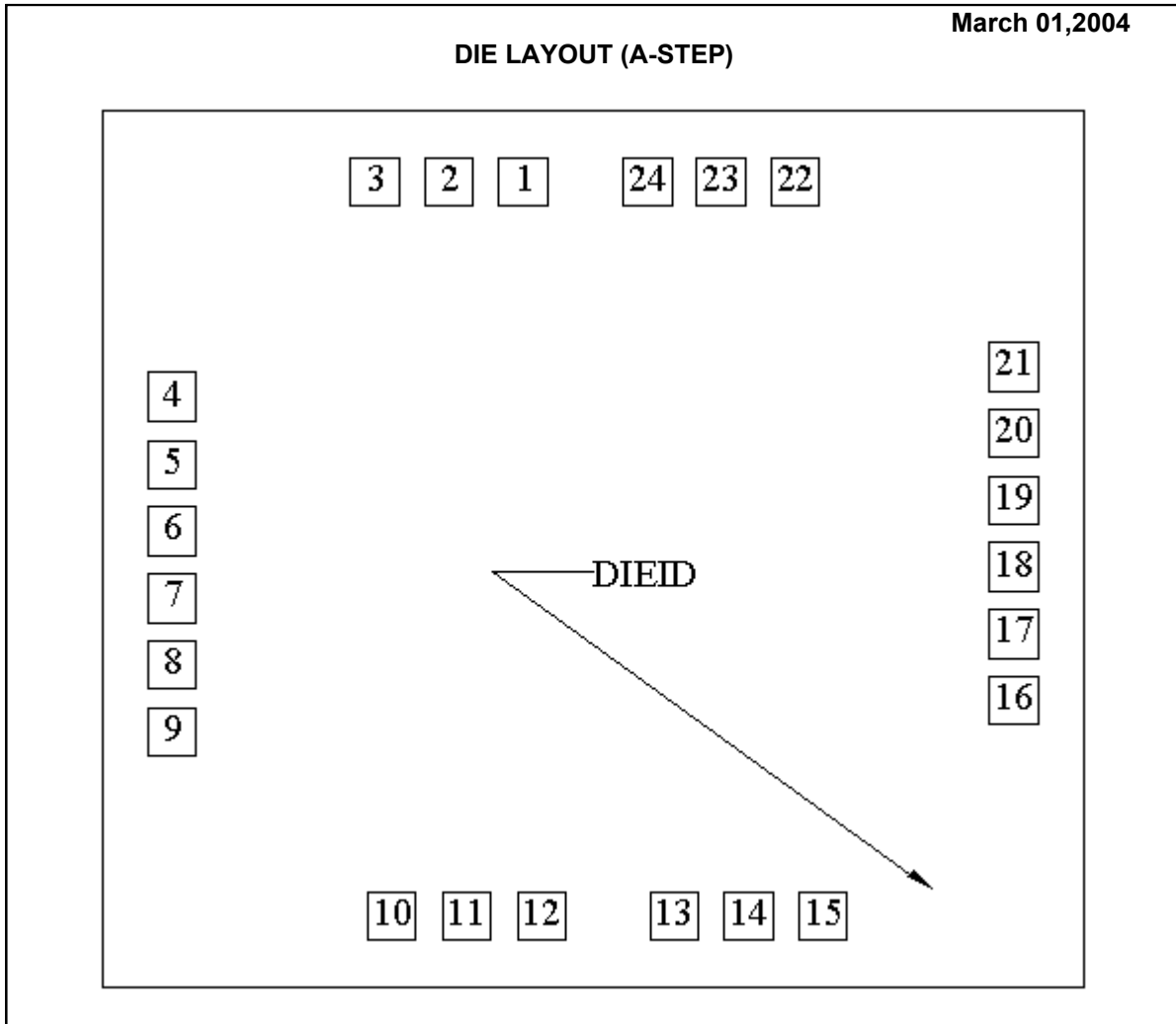


**ADC08100 MDC MWC
8-BIT, 20 MSPS TO 100 MSPS, 1.3 MW/MSPS A/D CONVERTER**



DIE/WAFER CHARACTERISTICS

Fabrication Attributes		General Die Information	
Physical Die Identification	ADC08100A	Bond Pad Opening Size (min)	92µm x 92µm
Die Step	A	Bond Pad Metalization	ALUMINUM
Physical Attributes		Passivation	NITRIDE OVER PASSIVATION OXIDE
Wafer Diameter	200mm	Back Side Metal	BARE BACK
Die Size (Drawn)	1867µm x 1664µm 73.5mils x 65.5mils	Back Side Connection	Floating
Thickness	254µm Nominal		
Min Pitch	127µm Nominal		

Special Assembly Requirements:

Note: Actual die size is rounded to the nearest micron.

ADC08100 MDC MWC

8-BIT, 20 MSPS TO 100 MSPS, 1.3 MW/MSPS A/D CONVERTER

Die Bond Pad Coordinate Locations (A -Step)

(Referenced to die center, coordinates in μm) **NC** = No Connection, **N.U.** = Not Used

SIGNAL NAME	PAD# NUMBER	X/Y COORDINATES		PAD SIZE		
		X	Y	X	Y	
VA	1	-132	698	92	x	92
AGND	2	-273	698	92	x	92
VRT	3	-414	698	92	x	92
VA	4	-800	289	92	x	92
AGND	5	-800	161	92	x	92
VIN	6	-800	34	92	x	92
VIN GND	7	-800	-93	92	x	92
AGND	8	-800	-220	92	x	92
VRM	9	-800	-347	92	x	92
VRB	10	-382	-698	92	x	92
AGND	11	-240	-698	92	x	92
VA	12	-98	-698	92	x	92
D7	13	154	-698	92	x	92
D6	14	296	-698	92	x	92
D5	15	438	-698	92	x	92
D4	16	800	-288	92	x	92
DR GND	17	800	-161	92	x	92
DRV D	18	800	-34	92	x	92
D3	19	800	93	92	x	92
D2	20	800	220	92	x	92
D1	21	800	347	92	x	92
D0	22	385	698	92	x	92
PD	23	244	698	92	x	92
CLK	24	104	698	92	x	92

ADC08100 MDC MWC
8-BIT, 20 MSPS TO 100 MSPS, 1.3 MW/MSPS A/D CONVERTER

Life Support Policy

NATIONAL'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF THE PRESIDENT OF NATIONAL SEMICONDUCTOR CORPORATION. As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in significant injury to the user.
2. A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety of effectiveness.



IN U.S.A.

Tel: 1 877 Dial Die (1 877 342 5343)
Fax: 1 207 541 6140

IN EUROPE

Tel: 49 (0) 8141 351492 / 1495
Fax: 49 (0) 8141 351470

IN ASIA PACIFIC

Tel: (852) 27371701

IN JAPAN

Tel: 81 043 299 2308

National Semiconductor does not assume any responsibility for use of any circuitry described, no circuit patent licenses are implied, and national reserves the right, at any time without notice, to change said circuitry or specifications.

National Semiconductor Corporation 2900 Semiconductor Drive, P.O. Box 58090, Santa Clara, California 95052-8090

IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, enhancements, improvements and other changes to its semiconductor products and services per JESD46, latest issue, and to discontinue any product or service per JESD48, latest issue. Buyers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All semiconductor products (also referred to herein as "components") are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its components to the specifications applicable at the time of sale, in accordance with the warranty in TI's terms and conditions of sale of semiconductor products. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by applicable law, testing of all parameters of each component is not necessarily performed.

TI assumes no liability for applications assistance or the design of Buyers' products. Buyers are responsible for their products and applications using TI components. To minimize the risks associated with Buyers' products and applications, Buyers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any patent right, copyright, mask work right, or other intellectual property right relating to any combination, machine, or process in which TI components or services are used. Information published by TI regarding third-party products or services does not constitute a license to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of significant portions of TI information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. TI is not responsible or liable for such altered documentation. Information of third parties may be subject to additional restrictions.

Resale of TI components or services with statements different from or beyond the parameters stated by TI for that component or service voids all express and any implied warranties for the associated TI component or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

Buyer acknowledges and agrees that it is solely responsible for compliance with all legal, regulatory and safety-related requirements concerning its products, and any use of TI components in its applications, notwithstanding any applications-related information or support that may be provided by TI. Buyer represents and agrees that it has all the necessary expertise to create and implement safeguards which anticipate dangerous consequences of failures, monitor failures and their consequences, lessen the likelihood of failures that might cause harm and take appropriate remedial actions. Buyer will fully indemnify TI and its representatives against any damages arising out of the use of any TI components in safety-critical applications.

In some cases, TI components may be promoted specifically to facilitate safety-related applications. With such components, TI's goal is to help enable customers to design and create their own end-product solutions that meet applicable functional safety standards and requirements. Nonetheless, such components are subject to these terms.

No TI components are authorized for use in FDA Class III (or similar life-critical medical equipment) unless authorized officers of the parties have executed a special agreement specifically governing such use.

Only those TI components which TI has specifically designated as military grade or "enhanced plastic" are designed and intended for use in military/aerospace applications or environments. Buyer acknowledges and agrees that any military or aerospace use of TI components which have **not** been so designated is solely at the Buyer's risk, and that Buyer is solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI has specifically designated certain components which meet ISO/TS16949 requirements, mainly for automotive use. Components which have not been so designated are neither designed nor intended for automotive use; and TI will not be responsible for any failure of such components to meet such requirements.

Products

Audio	www.ti.com/audio
Amplifiers	amplifier.ti.com
Data Converters	dataconverter.ti.com
DLP® Products	www.dlp.com
DSP	dsp.ti.com
Clocks and Timers	www.ti.com/clocks
Interface	interface.ti.com
Logic	logic.ti.com
Power Mgmt	power.ti.com
Microcontrollers	microcontroller.ti.com
RFID	www.ti-rfid.com
OMAP Applications Processors	www.ti.com/omap
Wireless Connectivity	www.ti.com/wirelessconnectivity

Applications

Automotive and Transportation	www.ti.com/automotive
Communications and Telecom	www.ti.com/communications
Computers and Peripherals	www.ti.com/computers
Consumer Electronics	www.ti.com/consumer-apps
Energy and Lighting	www.ti.com/energy
Industrial	www.ti.com/industrial
Medical	www.ti.com/medical
Security	www.ti.com/security
Space, Avionics and Defense	www.ti.com/space-avionics-defense
Video and Imaging	www.ti.com/video

TI E2E Community

e2e.ti.com